

Wiring, Printed - Component

COMPANY

Hangzhou Jiepei Information Technology Co Ltd

West Building 2 Room 1201

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E503141

Type	Cond Width		Min Cond Thk	SS/ DS/	Area Diam	Max Report date After	Surface Mount	Assembly		Solder Limits	Solder Oper Temp	Max	Meets C UL796 T	Class	DSR	I
	Min	Edge						Temp	Cycles							
Multilayer printed wiring board.																
JY-M	0.075	0.1	17 Int:68	DS	50.8	No	-	-	-	288	20	130	V-0	All		*
Single layer metal base printed wiring boards																
JY-A (ASP 1)	0.13	0.20	17	SS	50.8	Yes	Yes	260	1	288	10	130	V-0	All		*
JY-L (ASP 1)	0.13	0.20	25	SS	50.8	Yes	Yes	260	1	288	10	90	V-0	All		*
Single layer printed wiring boards.																
JY-D	0.075	0.1	17	DS	50.8	No	-	-	-	288	20	130	V-0	All		*

* - CTI marking is optional and may be marked on the printed wiring board.

(ASP 1) - Assembly Solder process evaluated to IPC-TM-650, 2.6.27 Thermal Stress Assembly Simulation.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or flammability classification..

Last Updated on 2023-05-24